



# PMEG6050CEP-Q

60 V, 5 A low VF Schottky barrier rectifier

17 March 2025

Product data sheet

## 1. General description

Planar Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Low forward voltage
- High power capability due to clip-bond technology
- Small and flat lead SMD plastic package
- Suitable for both reflow and wave soldering
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- Reverse polarity protection
- Low power consumption applications

## 4. Quick reference data



Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20$ kHz; square wave; $T_{sp} \leq 145$ °C	-	-	5	A
$V_R$	reverse voltage	$T_j = 25$ °C	-	-	60	V
$V_F$	forward voltage	$I_F = 5$ A; pulsed; $T_j = 25$ °C	[1]	630	720	mV
$I_R$	reverse current	$V_R = 60$ V; pulsed; $T_j = 25$ °C	[1]	60	150	$\mu$ A

[1] Very short pulse, in order to maintain a stable junction temperature.

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]	 CFP5 (SOD128)	 sym001
2	A	anode		

[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG6050CEP-Q	CFP5	plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG6050CEP-Q	GH

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	60	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> ≤ 145 °C		-	5	A
I <sub>FSM</sub>	non-repetitive peak forward current	t <sub>p</sub> = 8.3 ms; half-sine wave; T <sub>j(init)</sub> = 25 °C		-	50	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	750	mW
			[2]	-	1.25	W
T <sub>j</sub>	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.  
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	200	K/W
			[1] [3]	-	-	120	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[4]	-	-	12	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Soldering point of cathode tab.

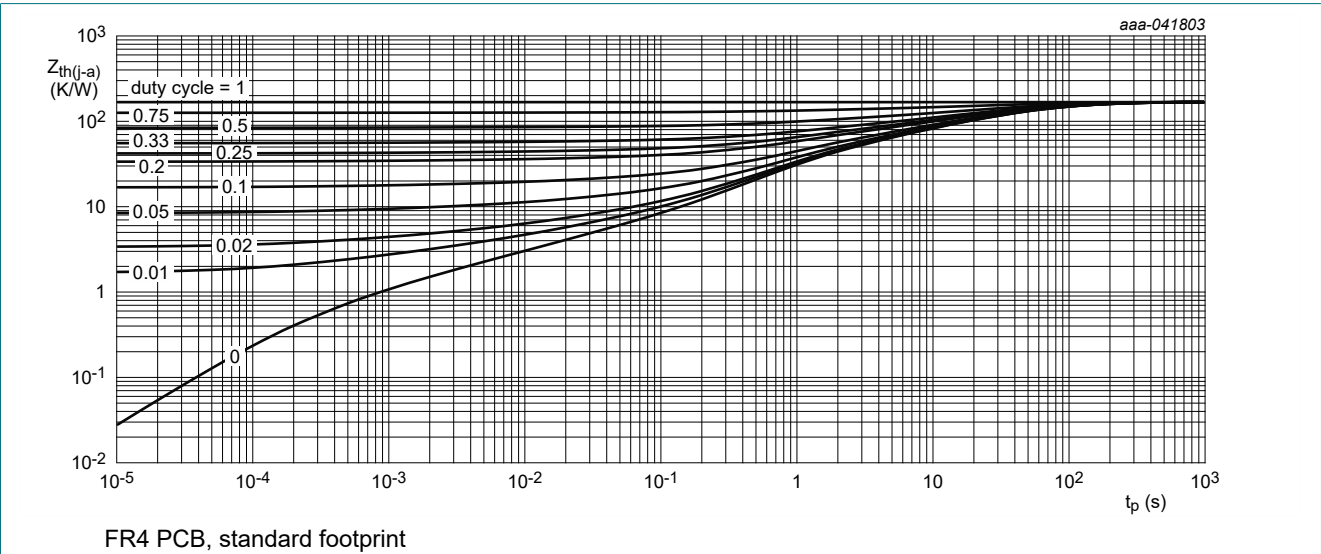


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

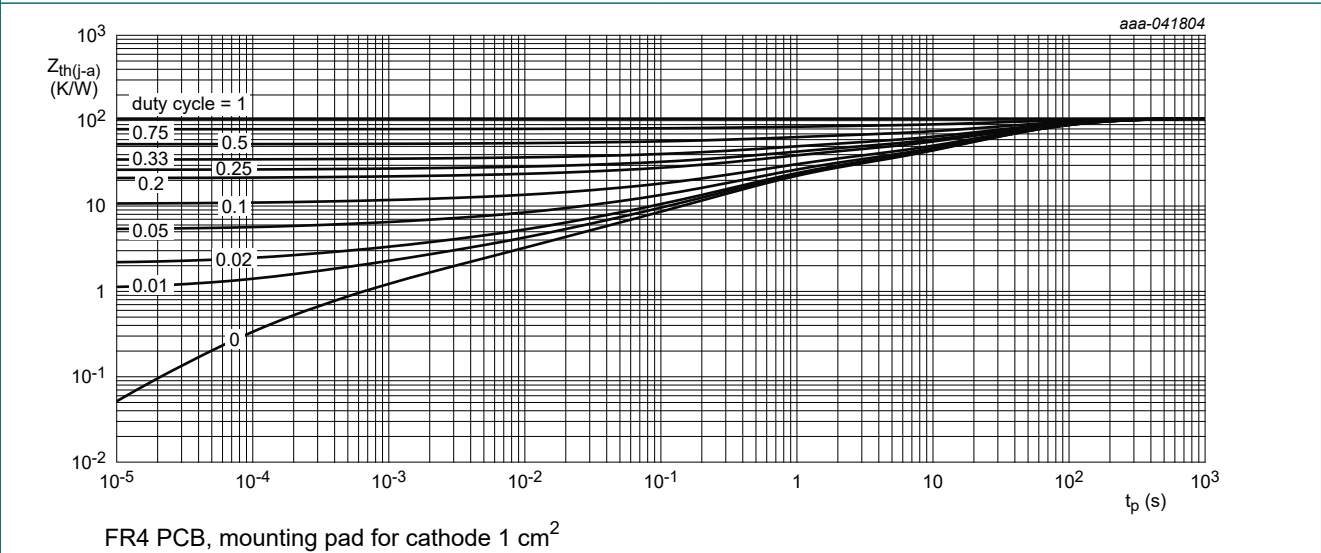


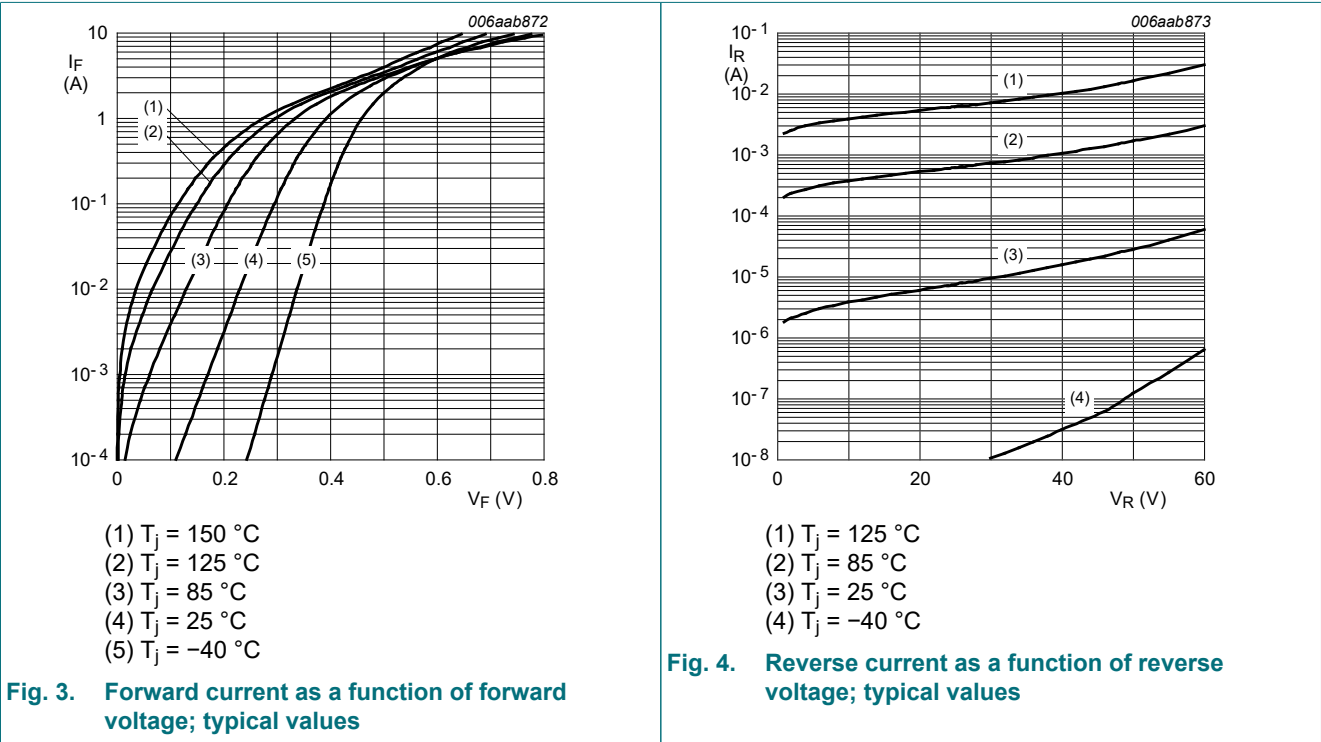
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

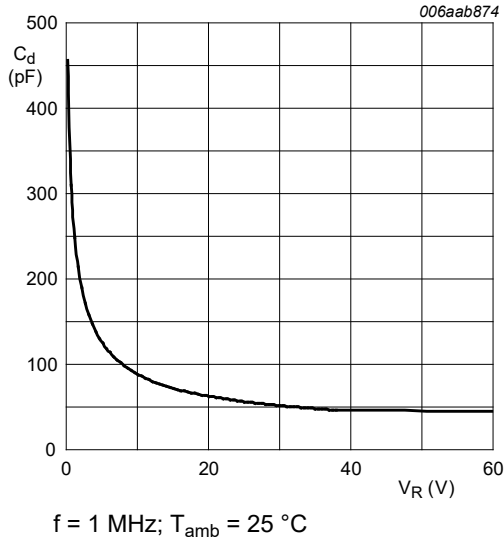
10. Characteristics

Table 7. Characteristics

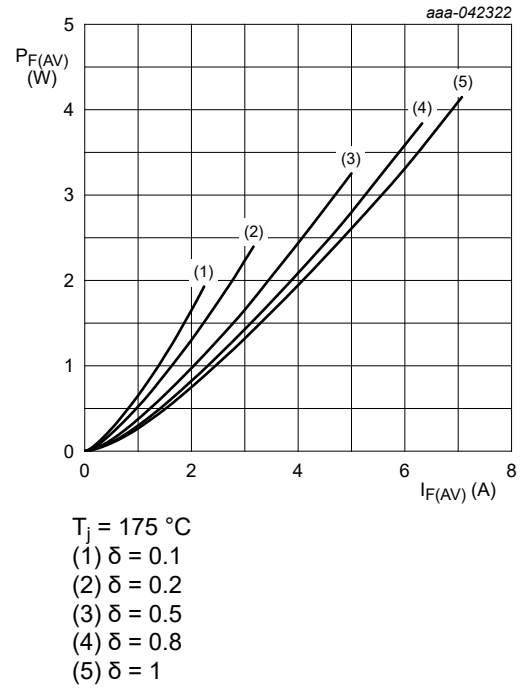
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	400	460	mV
		I <sub>F</sub> = 5 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	630	720	mV
		I <sub>F</sub> = 5 A; pulsed; T <sub>j</sub> = -40 °C	[1]	-	630	-	mV
		I <sub>F</sub> = 5 A; pulsed; T <sub>j</sub> = 125 °C	[1]	-	590	-	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 10 V; pulsed; T <sub>j</sub> = 25 °C	[1]	-	3.5	-	μA
		V <sub>R</sub> = 60 V; pulsed; T <sub>j</sub> = 25 °C	[1]	-	60	150	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	240	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	80	-	pF
t <sub>rr</sub>	reverse recovery time ramp recovery	diI <sub>F</sub> /dt = 200 A/μs; I <sub>F</sub> = 6 A; V <sub>R</sub> = 26 V; T <sub>j</sub> = 25 °C		-	8.5	-	ns
I <sub>RM</sub>	peak reverse recovery current			-	0.8	-	A
Q <sub>rr</sub>	reverse recovery charge			-	3.8	-	nC

[1] Very short pulse, in order to maintain a stable junction temperature.

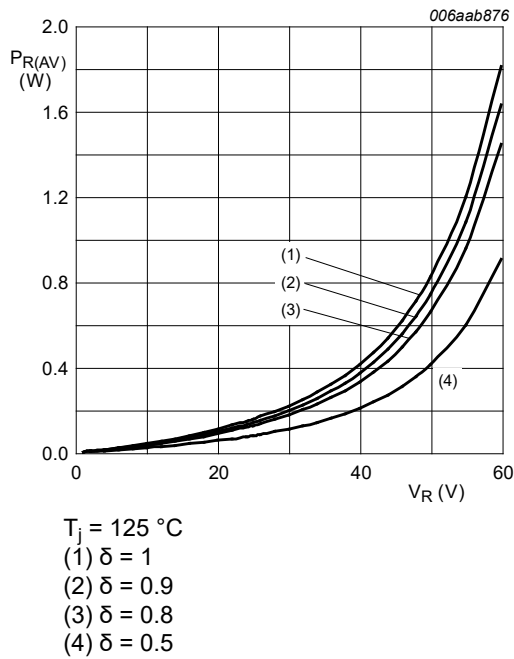




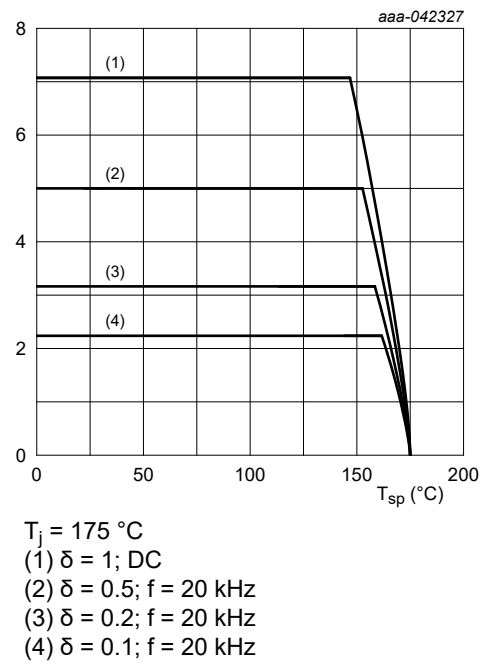
**Fig. 5.** Diode capacitance as a function of reverse voltage; typical values



**Fig. 6.** Average forward power dissipation as a function of average forward current; typical values



**Fig. 7.** Average reverse power dissipation as a function of reverse voltage; typical values



**Fig. 8.** Average forward current as a function of solder point temperature; typical values

## 11. Test information

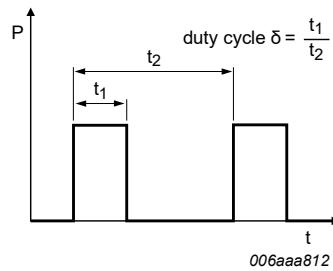


Fig. 9. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$$I_{F(AV)} = I_M \times \delta \text{ with } I_M \text{ defined as peak current}$$

$$I_{RMS} = I_{F(AV)} \text{ at DC}$$

$$I_{RMS} = I_M \times \sqrt{\delta} \text{ with } I_{RMS} \text{ defined as RMS current}$$

### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 12. Package outline

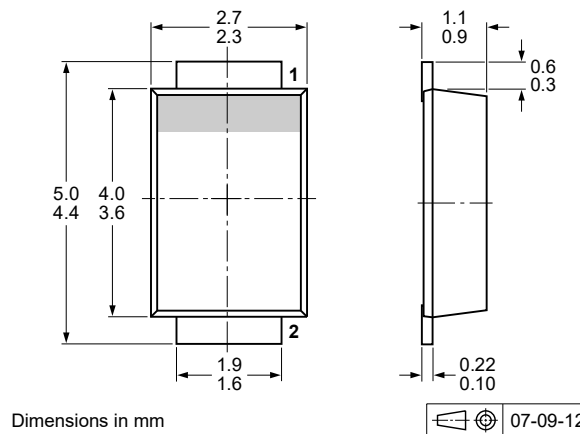
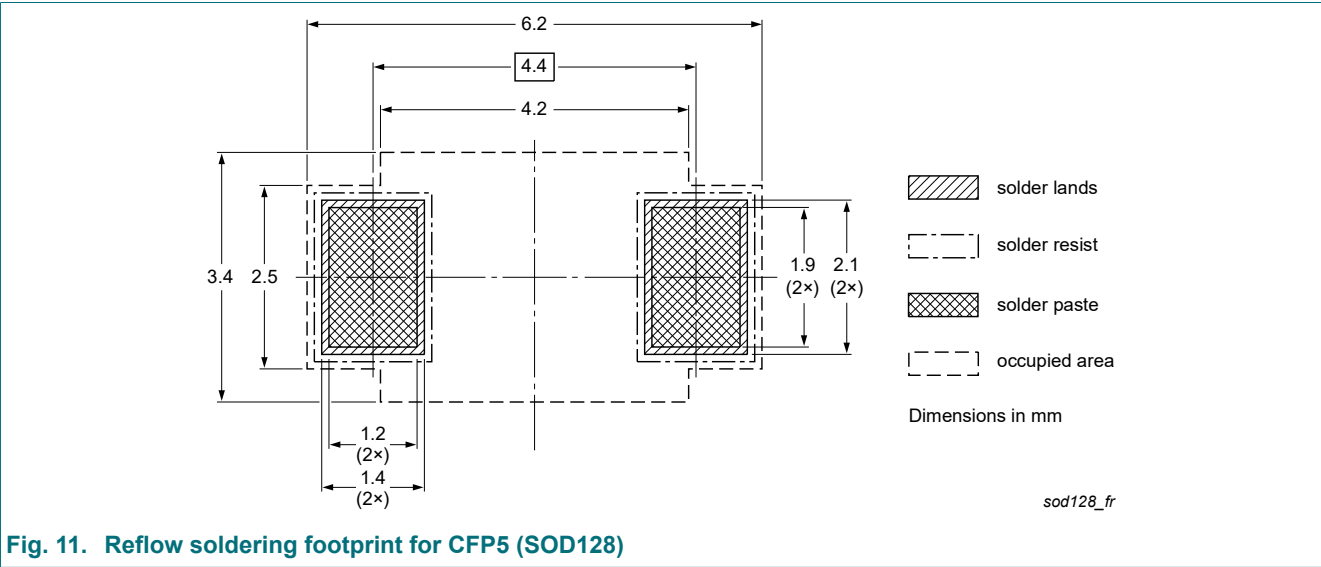


Fig. 10. Package outline CFP5 (SOD128)

13. Soldering



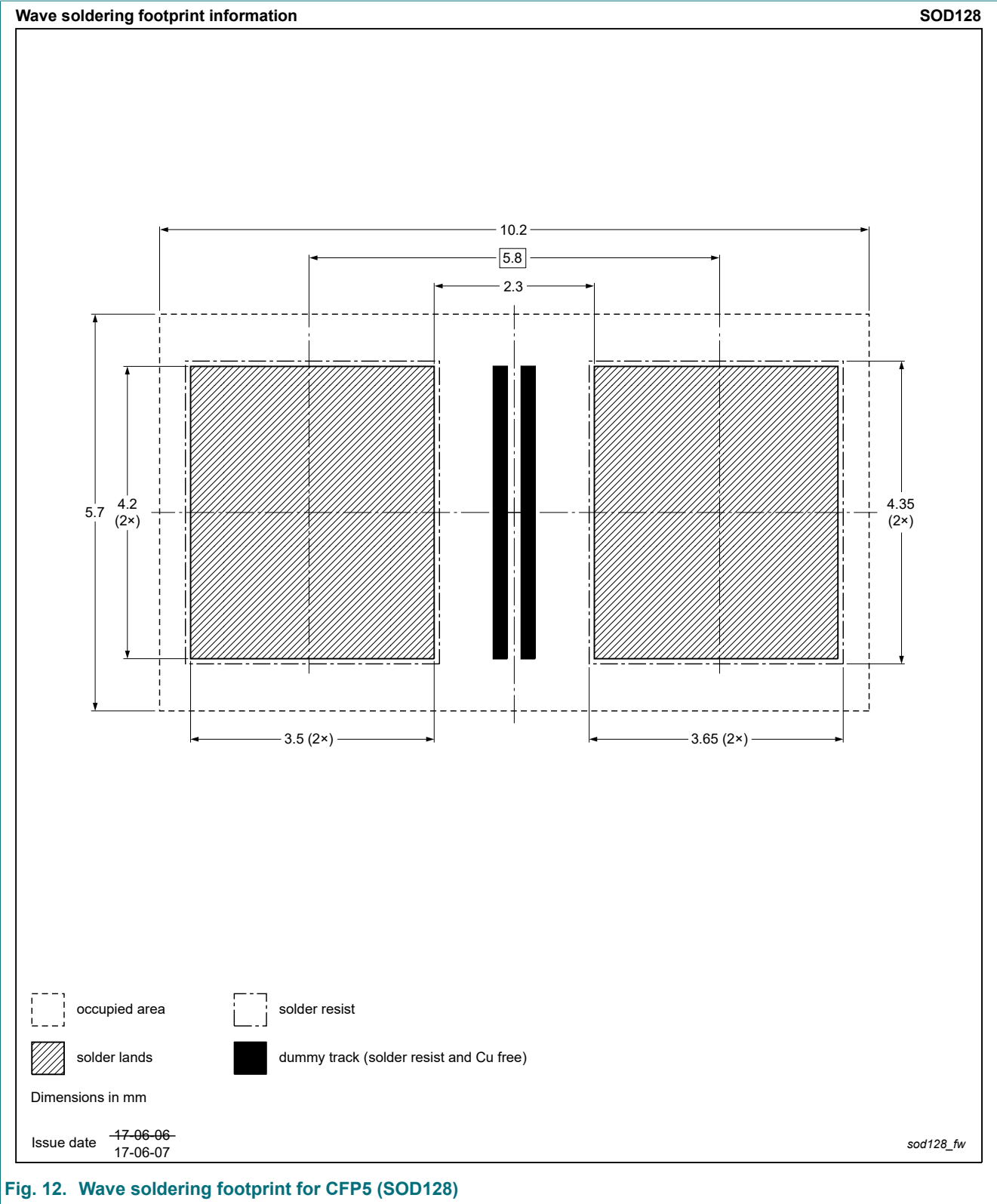


Fig. 12. Wave soldering footprint for CFP5 (SOD128)



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG6050CEP-Q v.2	20250317	Product data sheet	-	-
Modifications:	• Product status changed			
PMEG6050CEP-Q v.1	20250304	Objective data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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